

DESCRIPTION

The AG2113 is a high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels based on P_SUB P_EPI process. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600V. Logic inputs are compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications.

AG2113 is available in a SOP16 package.

ORDERING INFORMATION

Package Type	Part Number		
SOP16		AG2113M16R	
(wide body)	M16		
SPQ: 1,500pcs/Reel		AG2113M16VR	
Note	V: Halogen free Package		
Note	R: Tape & Reel		
AiT provides all RoHS products			

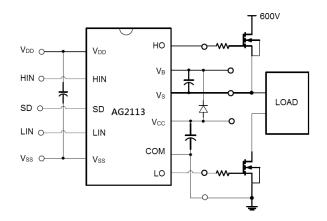
FEATURES

- Fully operational to +600V
- 3.3V logic compatible
- Floating channel designed for bootstrap operation
- Gate drive supply range from 10V to 20V
- UVLO for both channels
- Output Source / Sink Current Capability 3.0A /3.5A
- Separate logic supply range from 5.0V to 20V
- -6V negative Vs ability
- Matched propagation delay for both channels
- Available in a SOP16 package.

APPLICATION

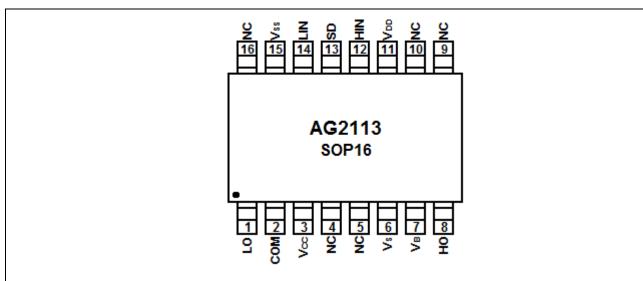
- High and medium-power motor driver
- Power MOSFET or IGBT driver
- Lighting ballast

TYPICAL APPLICATION CIRCUIT



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PIN DESCRIPTION



Top View

Pin#	Symbol	Function	
1	LO	Low side gate drive output, in phase with LIN	
2	СОМ	Low side return	
3	Vcc	Low side supply	
4,5,9,10,16	NC		
6	Vs	High side floating supply return	
7	V_{B}	High side floating supply	
8	НО	High side gate drive output, in phase with HIN	
11	V_{DD}	Logic supply	
12	HIN	Logic input for high side gate driver output (HO) , in phase	
13	SD	Logic input for shutdown	
14	LIN	Logic input for low side gate driver output (LO), in phase	
15	Vss	Logic ground	

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ABSOLUTE MAXIMUM RATINGS

V _B , High Side Floating Supply	-0.3V ~ 625V		
V _S , High Side Floating Supply Return		V_B -25V ~ V_B +0.3V	
V _{HO} , High Side Gate Drive Output		V_{S} -0.3V ~ V_{B} +0.3V	
V _{CC} , Low Side and Main Power Supply	-0.3V ~ 25V		
V _{LO} , Low Side Gate Drive Output	-0.3V ~ V _{CC} +0.3V		
V _{DD} , Logic supply	-0.3V ~ V _{CC} +0.3V		
Vss, Logic ground	V _{CC} -25V ~ V _{CC} +0.3V		
V _{IN} , Logic input		V_{SS} -0.3V ~ V_{DD} +0.3V	
dVs/dt, Allowable Offset Supply Voltage Transient		50V/ns	
ESD, HBM Model	2.5kV		
ESD, Machine Model		200V	
P _D , Package Power Dissipation @ T _A ≤25°C	SOP16	1.25W	
Rth _{JA} , Thermal Resistance Junction to Ambient	SOP16	100°C/W	
T _J , Junction Temperature	150°C		
T _S , Storage Temperature		-55°C~150°C	
T _L , Lead Temperature (Soldering, 10 seconds)		300°C	

Stress beyond above listed "Absolute Maximum Ratings" may lead permanent damage to the device. These are stress ratings only and operations of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Max.	Units
High Side Floating Supply	V _B	V _S +10	V _S +20	V
High Side Floating Supply Return	Vs	COM-6	600	V
High Side Gate Drive Output Voltage	V _{но}	Vs	V _B	V
Low Side Supply	Vcc	10	20	V
Low Side Gate Drive Output Voltage	V _{LO}	0	Vcc	V
Logic Supply	V_{DD}	Vss+3.3	Vss+20	V
Logic Ground	Vss	-5	5	V
Logic Input Voltage(HIN & LIN&SD)	Vin	0	Vcc	V
Ambient Temperature	T _A	-40	125	°C

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ELECTRICAL CHARACTERISTICS

V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF and T_A = 25°C, unless otherwise specified.

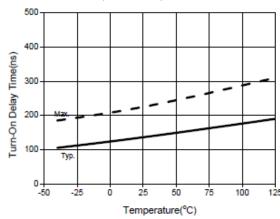
Parameter	Symbol	Conditions	Min	Тур.	Max	Units
Dynamic						
Turn-On Propagation Delay	ton		ı	135	220	ns
Turn-Off Propagation Delay	t _{off}		ı	130	220	
Shutdown Propagation Delay	t _{sd}		ı	135	220	
Delay Matching	MT		-	-	30	
Turn-On Rise Time	tr		-	20	30	
Turn-Off Fall Time	t f		-	15	25	
Static	, 					
Logic "1"(IN) Input Voltage	VIH		9.5	-	-	
Logic "0" (IN) Input Voltage	VıL		-	-	5	
High Level Output Voltage, V_{BIAS} - V_{O}	V _{OH}		1	-	1.4	V
Low Level Output Voltage, Vo	Vol		ı	ı	0.15	
Quiescent V _{DD} Supply Current	I_{QDD}		-	1	30	
Quiescent V _{CC} Supply Current	I _{QCC}		-	120	240	μΑ
Quiescent V _B Supply Current	I _{QBS}		-	75	150	
Leakage Current From V _S (600V) to GND	I _{LK}		-	1	10	
Logic "1" Input Bias Current	I _{IN} +		-	20	40	
Logic "0" Input Bias Current	I _{IN} -		-	1	5	
V _{BS} Supply UVLO Threshold	V _{BSU} +		7.5	8.4	9.7	
	V _{BSU} -		7	8	9.4	V
Vcc Supply UVLO Threshold	V _{CCU} +		7.4	8.4	9.6	V
	V _{CCU} -		7	8	9.4	
Output High Short Circuit Pulsed Current	l ₀ +		-	3.0	-	
Output Low Short Circuit Pulsed Current	l ₀ -			4.0	-	Α

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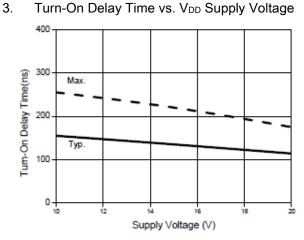


TYPICAL PERFORMANCE CHARACTERISTICS

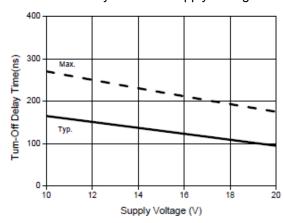
1. Turn-On Delay vs. Temperature



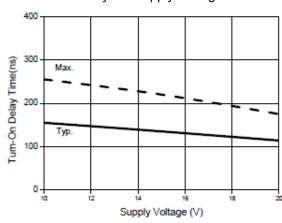
Tomporature(0)



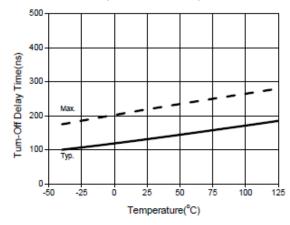
5. Turn-Off Delay Time vs. Supply Voltage



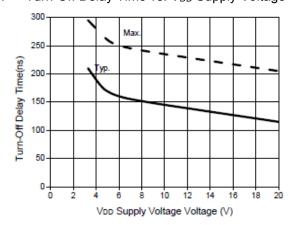
2. Turn-On Delay vs. Supply Voltage



4. Turn-Off Delay Time vs. Temperature



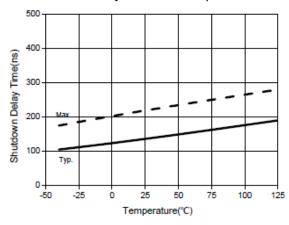
6. Turn-Off Delay Time vs. V_{DD} Supply Voltage



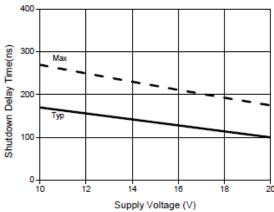
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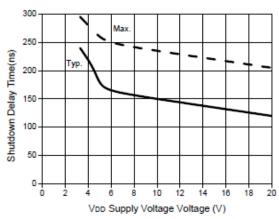
7. Shutdown Delay Time vs. Temperature



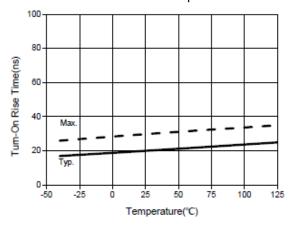
8. Shutdown Delay Time vs. Supply Voltage



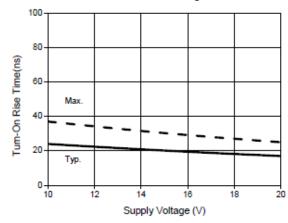
9. Shutdown Delay Time vs. V_{DD} Supply Voltage



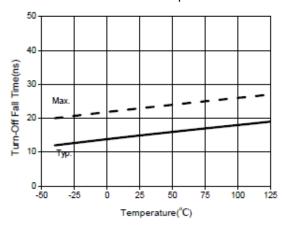
10. Turn-On Rise Time vs. Temperature



11. Turn-On Rise Time vs. Voltage



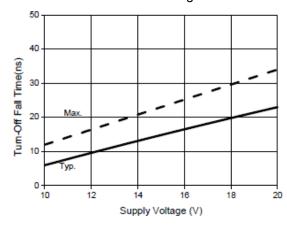
12. Turn-Off Fall Time vs. Temperature



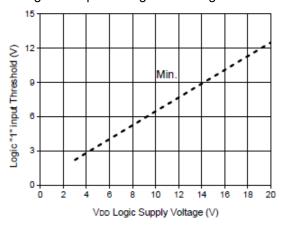
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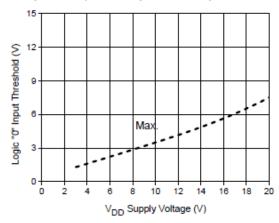
13. Turn-Off Fall Time vs. Voltage



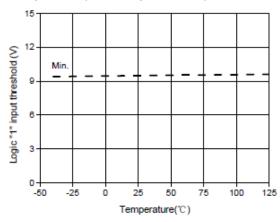
15. Logic "1" Input Voltage vs. Voltage



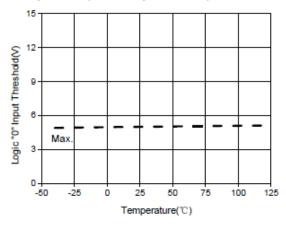
17. Logic "0" Input Voltage vs. Voltage



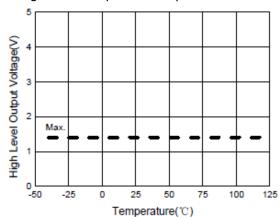
14. Logic "1" Input Voltage vs. Temperature



16. Logic "0" Input Voltage vs. Temperature



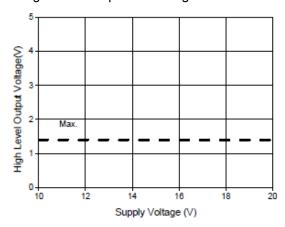
18. High Level Output vs. Temperature



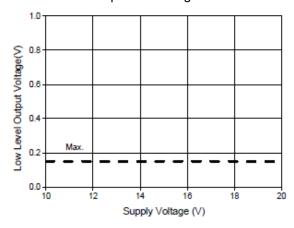
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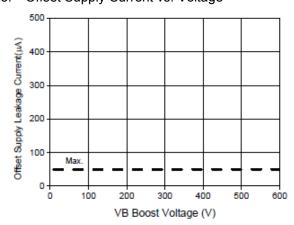
19. High Level Output vs. Voltage



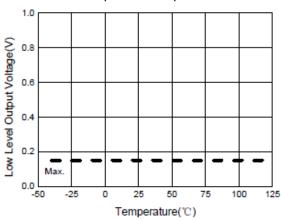
21. Low Level Output vs. Voltage



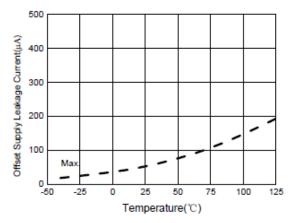
23. Offset Supply Current vs. Voltage



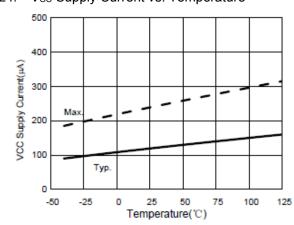
20. Low Level Output vs. Temperature



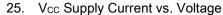
22. Offset Supply Current vs. Temperature

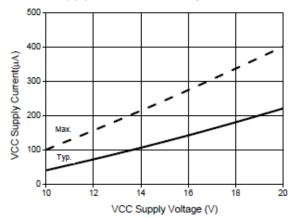


24. Vcc Supply Current vs. Temperature

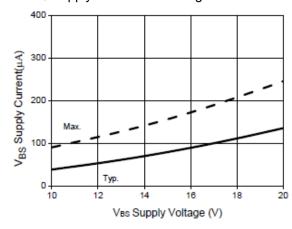


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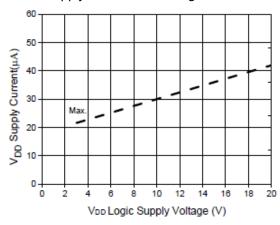




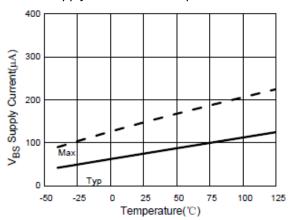
27. V_{BS} Supply Current vs. Voltage



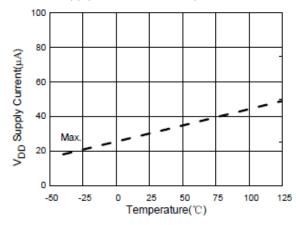
29. V_{DD} Supply Current vs. Voltage



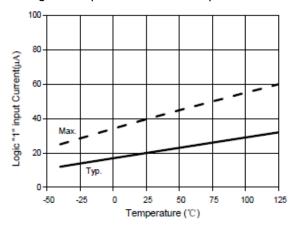
26. V_{BS} Supply Current vs. Temperature



28. V_{DD} Supply Current vs. Temperature



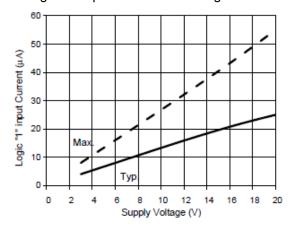
30. Logic "1" Input Current vs. Temperature



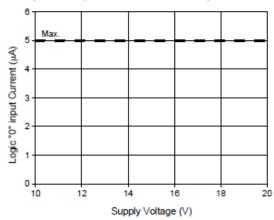
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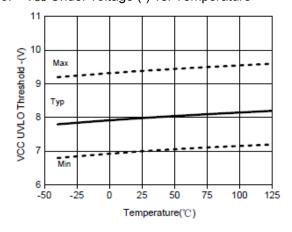
31. Logic "1" Input Current vs. Voltage



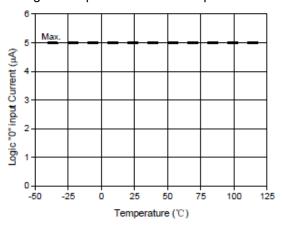
33. Logic "0" Input Current vs. Voltage



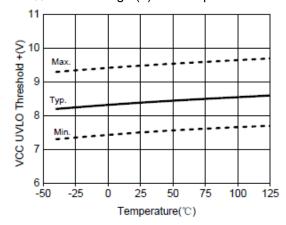
35. Vcc Under voltage (-) vs. Temperature



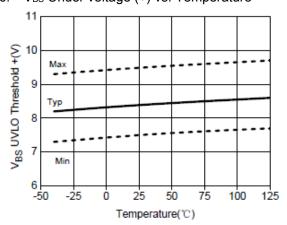
32. Logic "0" Input Current vs. Temperature



34. Vcc Under voltage (+) vs. Temperature



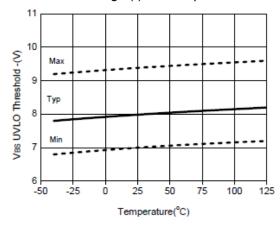
36. V_{BS} Under voltage (+) vs. Temperature



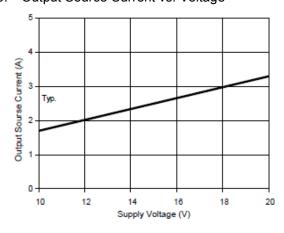
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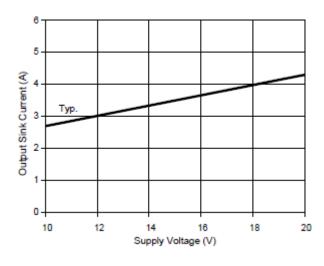
37. V_{BS} Under voltage (-) vs. Temperature



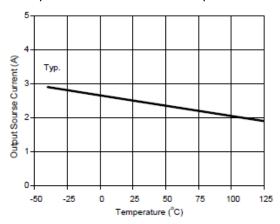
39. Output Source Current vs. Voltage



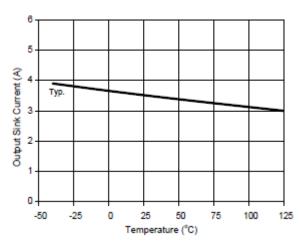
41. Output Sink Current vs. Voltage



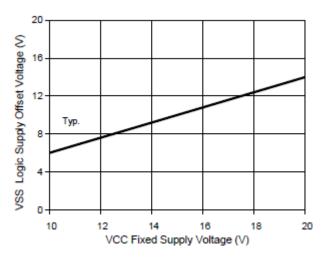
38. Output Source Current vs. Temperature



40. Output Sink Current vs. Temperature



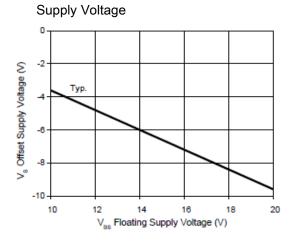
42. Maximum Vss Positive Offset vs. Vcc Supply Voltage



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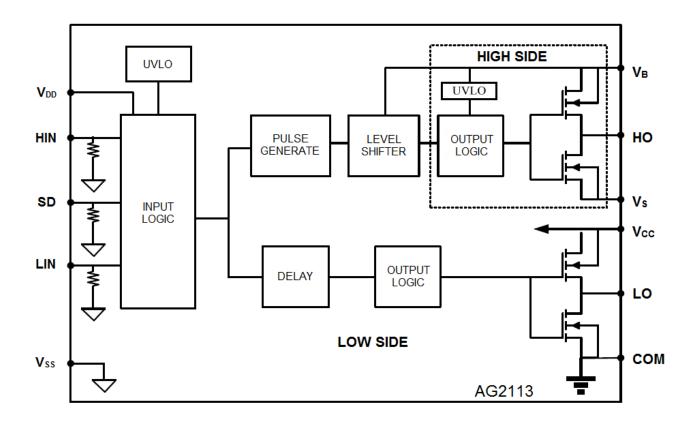


43. Maximum Vss Positive Offset vs. Vcc



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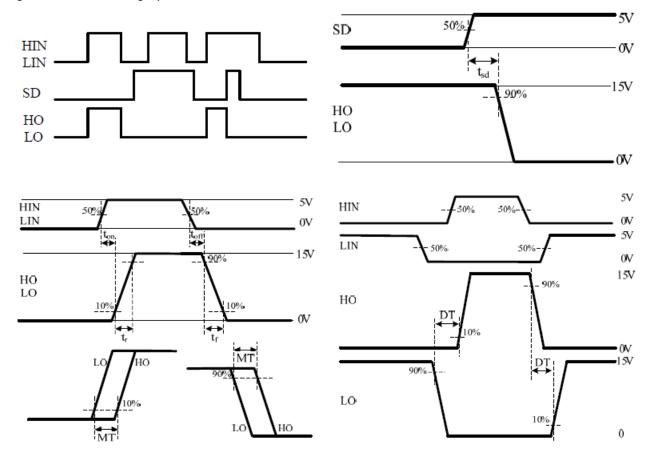
BLOCK DIAGRAM



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DETAILED INFORMATION

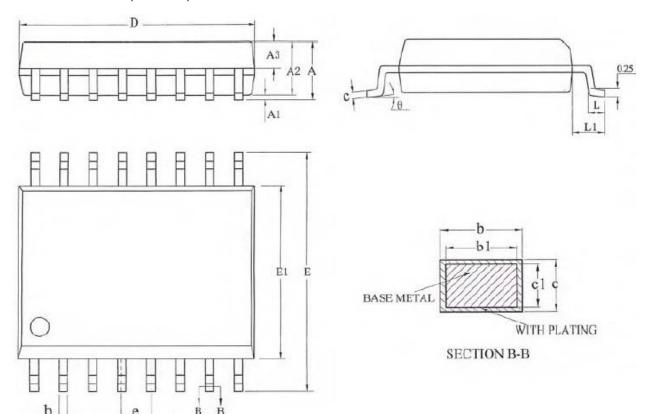
Logic Function & Timing Spec



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PACKAGE INFORMATION

Dimension in SOP16 (Unit: mm)



Symbol	Min.	Max.	
Α	-	2.65	
A1	0.10	0.30	
A2	2.25	2.35	
A3	0.97	1.07	
b	0.35	0.44	
b1	0.34	0.39	
С	0.25	0.31	
c1	0.24	0.26	
D	10.10	10.50	
Е	10.26	10.60	
E1	7.30	7.70	
е	1.27 BSC		
L	0.55	0.85	
L1	1.4 BSC		
θ	0°	8°	

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